16-BIT 2.5-V TO 3.3-V/3.3-V TO 5-V LEVEL-SHIFTING TRANSCEIVER WITH 3-STATE OUTPUTS

SCAS416I – MARCH 1994 – REVISED MAY 2002

- **Member of the Texas Instruments Widebus™ Family**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**

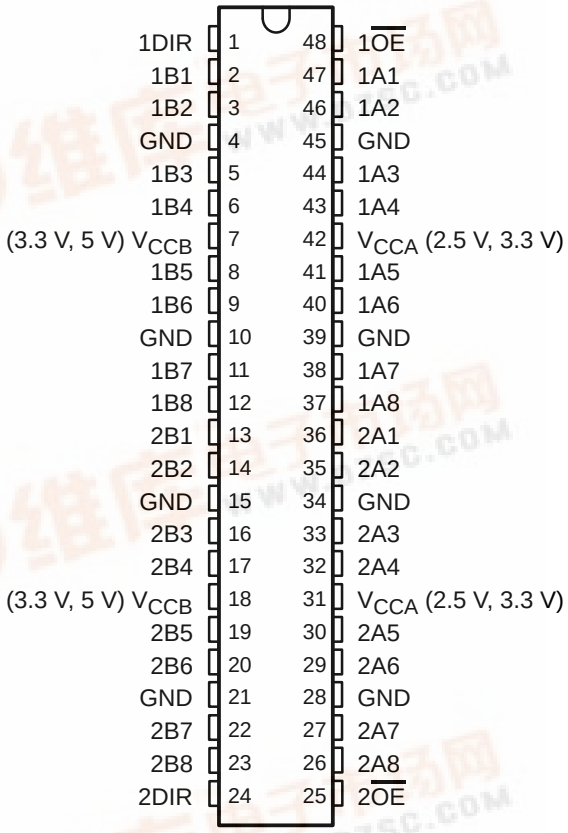
description

This 16-bit (dual-octal) noninverting bus transceiver contains two separate supply rails. B port has V_{CCB}, which is set to operate at 3.3 V and 5 V. A port has V_{CCA}, which is set to operate at 2.5 V and 3.3 V. This allows for translation from a 2.5-V to a 3.3-V environment, and vice versa, or from a 3.3-V to a 5-V environment, and vice versa.

The SN74ALVC164245 is designed for asynchronous communication between data buses.

To ensure the high-impedance state during power up or power down, the output-enable ($\overline{OE}$) input should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

DGG OR DL PACKAGE
(TOP VIEW)



ORDERING INFORMATION

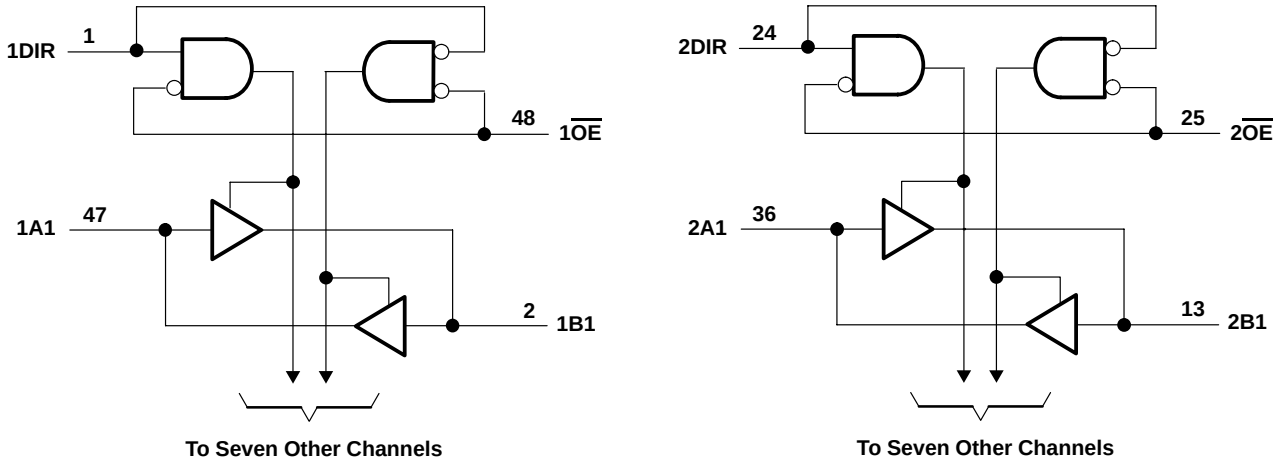
T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	SSOP – DL	Tube	SN74ALVC164245DL	ALVC164245
		Tape and reel	SN74ALVC164245DLR	
	TSSOP – DGG	Tape and reel	SN74ALVC164245DGGR	ALVC164245

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE
(each 8-bit section)

INPUTS		OPERATION
$\overline{OE}$	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range for V_{CCB} at 5 V and V_{CCA} at 3.3 V (unless otherwise noted)†

Supply voltage range: V_{CCA} . . . . . –0.5 V to 4.6 V
V_{CCB} . . . . . –0.5 V to 6 V
Input voltage range, V_I: Except I/O ports (see Note 1) . . . . . –0.5 V to 6 V
I/O port A (see Note 2) . . . . . –0.5 V to V_{CCA} + 0.5 V
I/O port B (see Note 1) . . . . . –0.5 V to V_{CCB} + 0.5 V
Input clamp current, I_{IK} (V_I < 0) . . . . . –50 mA
Output clamp current, I_{OK} (V_O < 0) . . . . . –50 mA
Continuous output current, I_O . . . . . ±50 mA
Continuous current through each V_{CC} or GND . . . . . ±100 mA
Package thermal impedance, θ_{JA} (see Note 3): DGG package . . . . . 70°C/W
DL package . . . . . 63°C/W
Storage temperature range, T_{stg} . . . . . –65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. This value is limited to 6 V maximum.
2. This value is limited to 4.6 V maximum.
3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions for V_{CCB} at 3.3 V and 5 V (see Note 4)

			MIN	MAX	UNIT
V_{CCB}	Supply voltage		3	5.5	V
V_{IH}	High-level input voltage		2		V
V_{IL}	Low-level input voltage	V_{CCB} = 3 V to 3.6 V		0.7	V
		V_{CCB} = 4.5 V to 5.5 V		0.8	
V_{IA}	Input voltage		0	V_{CCB}	V
V_{OB}	Output voltage		0	V_{CCB}	V
I_{OH}	High-level output current			–24	mA
I_{OL}	Low-level output current			24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate			10	ns/V
T_A	Operating free-air temperature		–40	85	°C

NOTE 4: All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

recommended operating conditions for V_{CCA} at 2.5 V and 3.3 V (see Note 4)

			MIN	MAX	UNIT
V_{CCA}	Supply voltage		2.3	3.6	V
V_{IH}	High-level input voltage	V_{CCA} = 2.3 V to 2.7 V	1.7		V
		V_{CCA} = 3 V to 3.6 V	2		
V_{IL}	Low-level input voltage	V_{CCA} = 2.3 V to 2.7 V		0.7	V
		V_{CCA} = 3 V to 3.6 V		0.8	
V_{IB}	Input voltage		0	V_{CCA}	V
V_{OA}	Output voltage		0	V_{CCA}	V
I_{OH}	High-level output current	V_{CCA} = 2.3 V		–18	mA
		V_{CCA} = 3 V		–24	
I_{OL}	Low-level output current	V_{CCA} = 2.3 V		18	mA
		V_{CCA} = 3 V		24	
$\Delta t/\Delta v$	Input transition rise or fall rate			10	ns/V
T_A	Operating free-air temperature		–40	85	°C

NOTE 4: All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range for V_{CCA} = 2.7 V to 3.6 V and V_{CCB} = 4.5 V to 5.5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V_{CCA}	V_{CCB}	MIN	TYP†	MAX	UNIT
V_{OH} (B to A)		I_{OH} = –100 µA	2.7 V to 3.6 V		V_{CC}–0.2			V
		I_{OH} = –12 mA	2.7 V		2.2			
			3 V		2.4			
		I_{OH} = –24 mA	3 V		2			
V_{OH} (A to B)		I_{OH} = –100 µA		4.5 V	4.3			V
				5.5 V	5.3			
		I_{OH} = –24 mA		4.5 V	3.7			
				5.5 V	4.7			
V_{OL} (B to A)		I_{OL} = 100 µA	2.7 V to 3.6 V				0.2	V
		I_{OL} = 12 mA	2.7 V				0.4	
		I_{OL} = 24 mA	3 V				0.55	
V_{OL} (A to B)		I_{OL} = 100 µA		4.5 V to 5.5 V			0.2	V
		I_{OL} = 24 mA		4.5 V to 5.5 V			0.55	
I_I	Control inputs	$V_I = V_{CCA}/V_{CCB}$ or GND	3.6 V	5.5 V			±5	µA
I_{OZ}‡	A or B ports	$V_O = V_{CCA}/V_{CCB}$ or GND	3.6 V	5.5 V			±10	µA
I_{CC}		$V_I = V_{CCA}/V_{CCB}$ or GND, I_O = 0	5.5 V	5.5 V			40	µA
ΔI_{CC}§		One input at V_{CCA}/V_{CCB} – 0.6 V, Other inputs at V_{CCA}/V_{CCB} or GND	3 V to 3.6 V	4.5 V to 5.5 V			750	µA
C_i	Control inputs	$V_I = V_{CCA}/V_{CCB}$ or GND	3.3 V	5 V		6.5		pF
C_{io}	A or B ports	$V_O = V_{CCA}/V_{CCB}$ or GND	3.3 V	3.3 V		8.5		pF

† Typical values are measured at V_{CCA} = 3.3 V and V_{CCB} = 5 V, T_A = 25°C.
‡ For I/O ports, the parameter I_{OZ} includes the input leakage current.
§ This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than at 0 or the associated V_{CC}.

electrical characteristics over recommended operating free-air temperature range for V_{CCA} = 2.3 V to 2.7 V and V_{CCB} = 3 V to 3.6 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V_{CCA}	V_{CCB}	MIN	MAX	UNIT
V_{OH} (B to A)		I_{OH} = –100 µA	2.3 V to 2.7 V	3 V to 3.6 V	V_{CCA}–0.2		V
		I_{OH} = –8 mA	2.3 V	3 V to 3.6 V	1.7		
		I_{OH} = –12 mA	2.7 V	3 V to 3.6 V	1.8		
V_{OH} (A to B)		I_{OH} = –100 µA	2.3 V to 2.7 V	3 V to 3.6 V	V_{CCB}–0.2		V
		I_{OH} = –18 mA	2.3 V to 2.7 V	3 V	2.2		
V_{OL} (B to A)		I_{OL} = 100 µA	2.3 V to 2.7 V	3 V to 3.6 V		0.2	V
		I_{OL} = 12 mA	2.3 V	3 V to 3.6 V		0.6	
V_{OL} (A to B)		I_{OL} = 100 µA	2.3 V to 2.7 V	3 V to 3.6 V		0.2	V
		I_{OL} = 18 mA	2.3 V	3 V		0.55	
I_I	Control inputs	$V_I = V_{CCA}/V_{CCB}$ or GND	2.3 V to 2.7 V	3 V to 3.6 V		±5	µA
I_{OZ}‡	A or B ports	$V_O = V_{CCA}/V_{CCB}$ or GND	2.3 V to 2.7 V	3 V to 3.6 V		±10	µA
I_{CCA}		$V_I = V_{CCA}/V_{CCB}$ or GND, I_O = 0	2.3 V to 2.7 V	3 V to 3.6 V		20	µA
ΔI_{CC}§		One input at V_{CCA}/V_{CCB} – 0.6 V, Other inputs at V_{CCA}/V_{CCB} or GND	2.3 V to 2.7 V	3 V to 3.6 V		750	µA

‡ For I/O ports, the parameter I_{OZ} includes the input leakage current.
§ This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than at 0 or the associated V_{CC}.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1-4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CCB} = 3.3 V ± 0.3 V		V_{CCB} = 5 V ± 0.5 V				UNIT
			V_{CCA} = 2.5 V ± 0.2 V		V_{CCA} = 2.7 V		V_{CCA} = 3.3 V ± 0.3 V		
			MIN	MAX	MIN	MAX	MIN	MAX	
t_{pd}	A	B		7.6		5.9	1	5.8	ns
	B	A		7.6		6.7	1.2	5.8	
t_{en}	$\overline{OE}$	B		11.5		9.3	1	8.9	ns
t_{dis}	$\overline{OE}$	B		10.5		9.2	2.1	9.5	ns
t_{en}	$\overline{OE}$	A		12.3		10.2	2	9.1	ns
t_{dis}	$\overline{OE}$	A		9.3		9	2.9	8.6	ns

operating characteristics, T_A = 25°C

PARAMETER			TEST CONDITIONS	V_{CCB} = 3.3 V, V_{CCA} = 2.5 V	V_{CCB} = 5 V, V_{CCA} = 3.3 V	UNIT
				TYP	TYP	
C_{pd}	Power dissipation capacitance	Outputs enabled (B)	C_L = 50 pF, f = 10 MHz	55	56	pF
		Outputs disabled (B)		27	6	
		Outputs enabled (A)	C_L = 50 pF, f = 10 MHz	118	56	
		Outputs disabled (A)		58	6	

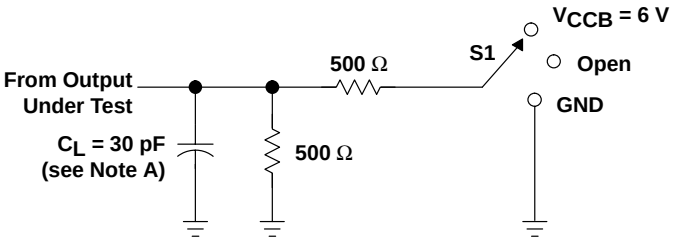
power-up considerations†

TI level-translation devices offer an opportunity for successful mixed-voltage signal design. A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins. Take these precautions to guard against such power-up problems.

1. Connect ground before any supply voltage is applied.
2. Next, power up the control side of the device (V_{CCA} for all four of these devices).
3. Tie $\overline{OE}$ to V_{CCA} with a pullup resistor so that it ramps with V_{CCA}.
4. Depending on the direction of the data path, DIR can be high or low. If DIR high is needed (A data to B bus), ramp it with V_{CCA}. Otherwise, keep DIR low.

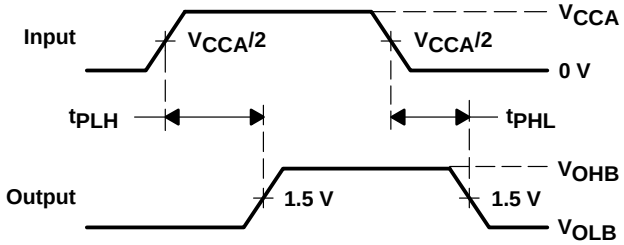
† Refer to the TI application report, *Texas Instruments Voltage-Level-Translation Devices*, literature number SCEA021.

PARAMETER MEASUREMENT INFORMATION
V_{CCA}= 2.5 V ± 0.2 V TO V_{CCB}= 3.3 V ± 0.3 V

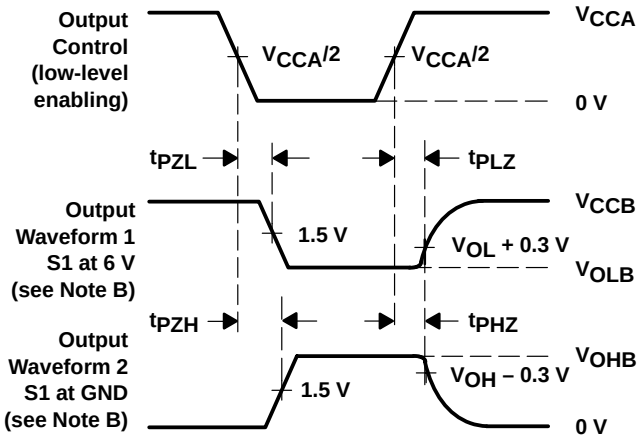


LOAD CIRCUIT

TEST	S1
t_{pd} t_{PLZ}/t_{PZL} t_{PHZ}/t_{PZH}	Open V_{CCB} = 6 V GND



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

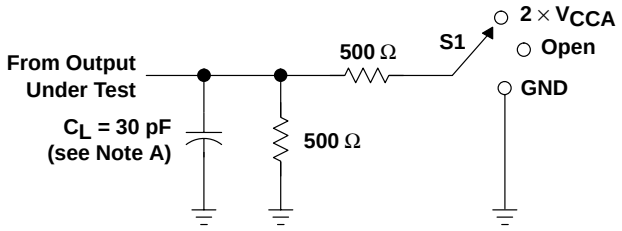


VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR≤10 MHz, Z_O = 50 Ω, t_r≤2 ns, t_f≤2 ns.
D. The outputs are measured one at a time with one transition per measurement.
E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
F. t_{PZL} and t_{PZH} are the same as t_{en}.
G. t_{PLH} and t_{PHL} are the same as t_{pd}.

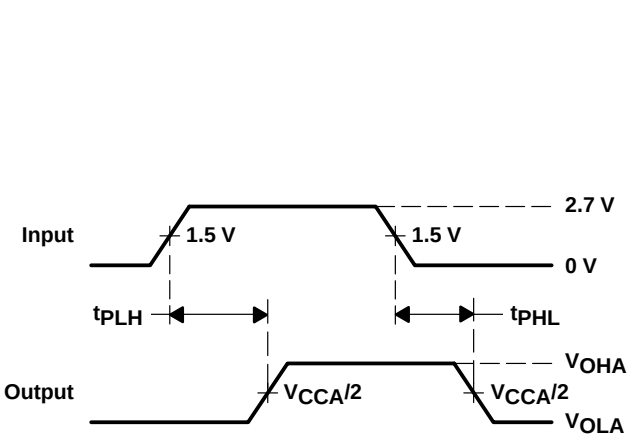
Figure 1. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION
V_{CCB} = 3.3 V ± 0.3 V TO V_{CCA} = 2.5 V ± 0.2 V

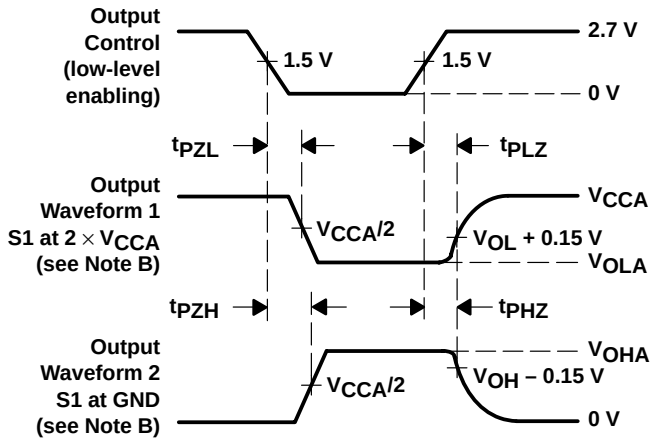


LOAD CIRCUIT

TEST	S1
t_{pd} t_{PLZ}/t_{PZL} t_{PHZ}/t_{PZH}	Open 2 × V_{CCA} GND



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

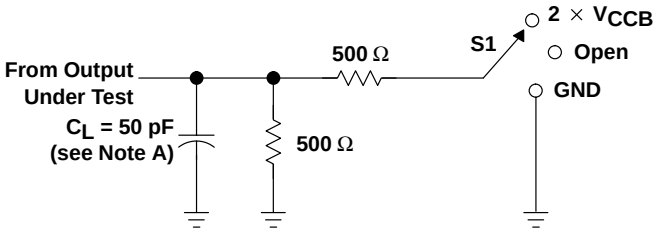


VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR≤10 MHz, Z_O = 50 Ω, t_r≤2 ns, t_f≤2 ns.
D. The outputs are measured one at a time with one transition per measurement.
E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
F. t_{PZL} and t_{PZH} are the same as t_{en}.
G. t_{PLH} and t_{PHL} are the same as t_{pd}.

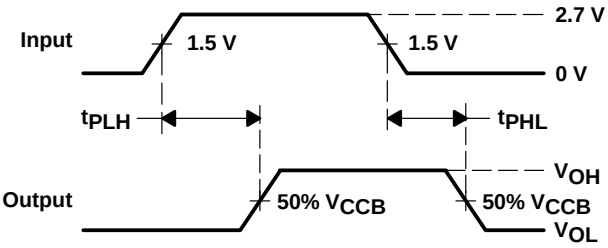
Figure 2. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION
V_{CCA} = 3.3 V ± 0.3 V TO V_{CCB} = 5 V ± 0.5 V

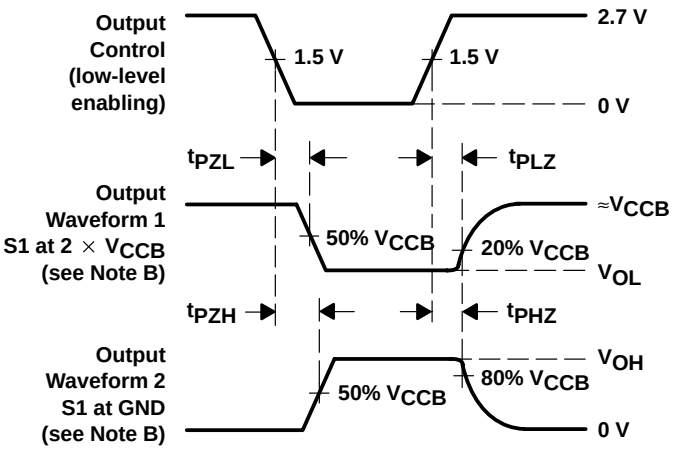


LOAD CIRCUIT

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	2 × V_{CCB}
t_{PHZ}/t_{PZH}	GND



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

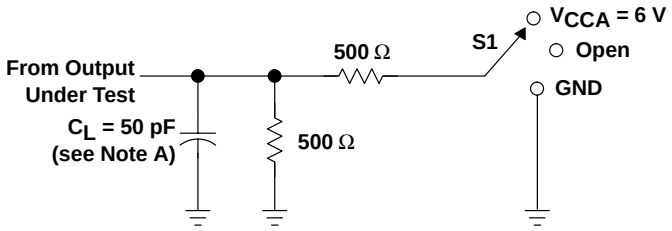


VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.
D. The outputs are measured one at a time with one transition per measurement.
E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
F. t_{PZL} and t_{PZH} are the same as t_{en}.
G. t_{PLH} and t_{PHL} are the same as t_{pd}.

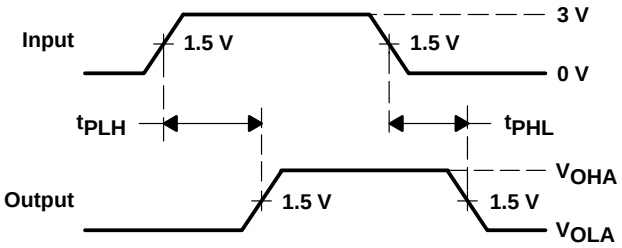
Figure 3. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION
V_{CCB} = 5 V ± 0.5 V TO V_{CCA} = 2.7 V AND 3.3 V ± 0.3 V

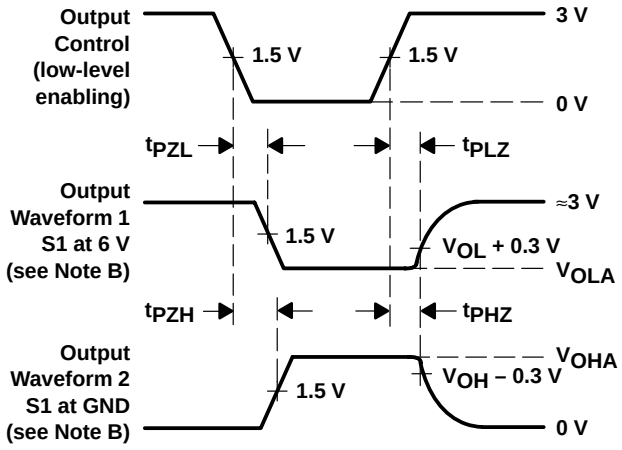


LOAD CIRCUIT

TEST	S1
t_{pd} t_{PLZ}/t_{PZL} t_{PHZ}/t_{PZH}	Open V_{CCA} = 6 V GND



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

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C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.
D. The outputs are measured one at a time with one transition per measurement.
E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
F. t_{PZL} and t_{PZH} are the same as t_{en}.
G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 4. Load Circuit and Voltage Waveforms

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